501993549 07/18/2012

PATENT ASSIGNMENT

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SUBMISSION TYPE:	NEW ASSIGNMENT
NATURE OF CONVEYANCE:	ASSIGNMENT

CONVEYING PARTY DATA

Name	Execution Date
Mitsuhiro ASHIKAGA	07/09/2012
Masaki SHIINA	07/09/2012
Yasuo IWASA	07/02/2012

RECEIVING PARTY DATA

Name:	YUPO CORPORATION
Street Address:	3, Kandasurugadai 4-chome, Chiyoda-ku
City:	Tokyo
State/Country:	JAPAN
Postal Code:	101-0062

PROPERTY NUMBERS Total: 1

Property Type	Number
Application Number:	13501873

CORRESPONDENCE DATA

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ATTORNEY DOCKET NUMBER:	P41718
NAME OF SUBMITTER:	Sean Myers-Payne

Total Attachments: 4

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> PATENT REEL: 028579 FRAME: 0389

OF \$40.00 13501873

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ASSIGNMENT

WHEREAS, **Mitsuhiro ASHIKAGA**, a citizen of JAPAN, whose post office address is c/o YUPO CORPORATION, KASHIMA FACTORY, 23, Touwada, Kamisu-shi, Ibaraki 314-0102 JAPAN, **Masaki SHIINA**, a citizen of JAPAN, whose post office address is c/o YUPO CORPORATION, KASHIMA FACTORY, 23, Touwada, Kamisu-shi, Ibaraki 314-0102 JAPAN, and **Yasuo IWASA**, a citizen of JAPAN, whose post office address is c/o YUPO CORPORATION, KASHIMA FACTORY, 23, Touwada, Kamisu-shi, Ibaraki 314-0102 JAPAN, hereinafter referred to as the ASSIGNORS, have invented a certain improvement relating to

LABEL FOR IN-MOLD MOLDING, IN-MOLD MOLDED ARTICLE AND METHOD FOR MOLDING SAME

for which an application for Letters Patent in the United States entered the National Stage in the United States Patent and Trademark Office on April 13, 2012 and was awarded Application No. 13/501,873, and which Application is a National Stage of International Application No. PCT/JP2010/067909, filed October 13, 2010.

AND WHEREAS, **YUPO CORPORATION**, a corporation organized and existing under the laws of JAPAN, whose post-office address is 3, Kandasurugadai 4-chome, Chiyoda-ku, Tokyo 101-0062 JAPAN, hereinafter known as the ASSIGNEE, is desirous of acquiring the entire right, title and interest for the United States in and to said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof.

NOW, THIS WITNESSETH that for and in consideration of One Dollar (\$1.00) and other good and valuable consideration, the receipt whereof is hereby acknowledged, said ASSIGNORS hereby assign, sell and transfer to said ASSIGNEE, its assigns and legal representatives, the entire and exclusive right, title and interest in and to said invention and application, for the United States including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted therefor and all rights to sue for past and future infringement thereunder, said ASSIGNEE and its assigns and legal representatives to have, hold, exercise and enjoy the said invention and application, including any and all divisions and continuations thereof, and any and all Letters Patent which may be granted thereon, including any and all renewals, reissues, reexaminations, and prolongations thereof, with all the rights, powers, privileges, and advantages in any ways arising from or pertaining thereto, for and during the term or terms of any and all such Letters Patent when granted, including any and all renewals, reissues, reexaminations, and prolongations thereof, for the use and benefit of said ASSIGNEE and its assigns and legal representatives in as ample and beneficial a manner to all intents and purposes as the said ASSIGNORS might or could have held and enjoyed the same, if this assignment had not been made.

AND said ASSIGNORS hereby agree to execute all papers necessary to file applications in the United States for said invention and to assign the same to said ASSIGNEE, or any assignee acquiring title to said invention, and to execute any other papers that may be needed in connection with filing said application and securing Letters Patent thereon.

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AND said ASSIGNORS authorize and request the Commissioner of Patents to issue Letters Patent on said application, and on any and all divisions and continuations thereof, to said ASSIGNEE, its assigns and legal representatives, in accordance herewith.

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

R	oh Nakamura
(Name)	Kou NAKAMURA
(Date)	July 9, 2012

Mitsuhiro Ashikaga
Mitsuhiro ASHIKAGA

July 9, 2012

Date

Second Witness:

First Witness:

Tatsuya Suzuki
(Name) Tatsuya Suzuki

July 9, 2012 (Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

(Name) Kazuyuki KIMURA

July 9, 2012 (Date)

<u>Mutafer Muior</u> Masaki SHIINA

July 9, 2012

Date

Second Witness:

(Name) Takahiko UEDA

July 9, 2012

(Date)

IN TESTIMONY WHEREOF, this assignment is executed by said ASSIGNOR(S), on the respective date(s) indicated below.

First Witness:

(Name)

Masakuni FUKUTOME

July 2, 2012

(Date)

Yasuq IWASA

July 2, 2012

Date

Second Witness:

(Name)

Kei KAGAYAMA

July 2, 2012

(Date)